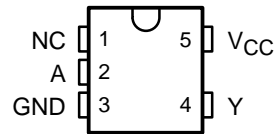


SN74AHC1G04 SINGLE INVERTER GATE

SCLS318N – MARCH 1996 – REVISED MARCH 2003

- Operating Range of 2 V to 5.5 V
- Max t_{pd} of 6.5 ns at 5 V
- Low Power Consumption, 10- μ A Max I_{CC}
- ± 8 -mA Output Drive at 5 V
- Latch-Up Performance Exceeds 250 mA Per JESD 17

DBV OR DCK PACKAGES
(TOP VIEW)



NC – No internal connection

description/ordering information

The SN74AHC1G04 contains one inverter gate. The device performs the Boolean function $Y = \bar{A}$.

ORDERING INFORMATION

| T_A | PACKAGE† | | ORDERABLE PART NUMBER | TOP-SIDE MARKING‡ |
|---------------|--------------------|--------------|-----------------------|-------------------|
| -40°C to 85°C | SOT (SOT-23) – DBV | Reel of 3000 | SN74AHC1G04DBVR | A04_ |
| | | Reel of 250 | SN74AHC1G04DBVT | |
| | SOT (SC-70) – DCK | Reel of 3000 | SN74AHC1G04DCKR | AC_ |
| | | Reel of 250 | SN74AHC1G04DCKT | |

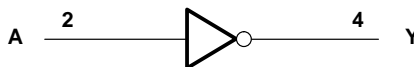
† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

‡ The actual top-side marking has one additional character that designates the assembly/test site.

FUNCTION TABLE

| INPUT A | OUTPUT Y |
|------------|-------------|
| H | L |
| L | H |

logic diagram (positive logic)



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

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SN74AHC1G04

SINGLE INVERTER GATE

SCLS318N – MARCH 1996 – REVISED MARCH 2003

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|--------------------------------------------------------------------|----------------------------|
| Supply voltage range, V_{CC} | -0.5 V to 7 V |
| Input voltage range, V_I (see Note 1) | -0.5 V to 7 V |
| Output voltage range, V_O (see Note 1) | -0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, I_{IK} ($V_I < 0$) | -20 mA |
| Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) | ±20 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | ±25 mA |
| Continuous current through V_{CC} or GND | ±50 mA |
| Package thermal impedance, θ_{JA} (see Note 2): DBV package | 206°C/W |
| DCK package | 252°C/W |
| Storage temperature range, T_{stg} | -65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

| | | MIN | MAX | UNIT |
|---------------------|------------------------------------|--------------------------|----------|------|
| V_{CC} | Supply voltage | 2 | 5.5 | V |
| V_{IH} | High-level input voltage | $V_{CC} = 2$ V | 1.5 | V |
| | | $V_{CC} = 3$ V | 2.1 | |
| | | $V_{CC} = 5.5$ V | 3.85 | |
| V_{IL} | Low-level input voltage | $V_{CC} = 2$ V | 0.5 | V |
| | | $V_{CC} = 3$ V | 0.9 | |
| | | $V_{CC} = 5.5$ V | 1.65 | |
| V_I | Input voltage | 0 | 5.5 | V |
| V_O | Output voltage | 0 | V_{CC} | V |
| I_{OH} | High-level output current | $V_{CC} = 2$ V | -50 | μA |
| | | $V_{CC} = 3.3$ V ± 0.3 V | -4 | mA |
| | | $V_{CC} = 5$ V ± 0.5 V | -8 | |
| I_{OL} | Low-level output current | $V_{CC} = 2$ V | 50 | μA |
| | | $V_{CC} = 3.3$ V ± 0.3 V | 4 | mA |
| | | $V_{CC} = 5$ V ± 0.5 V | 8 | |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | $V_{CC} = 3.3$ V ± 0.3 V | 100 | ns/V |
| | | $V_{CC} = 5$ V ± 0.5 V | 20 | |
| T_A | Operating free-air temperature | -40 | 85 | °C |

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | V _{CC} | T _A = 25°C | | | MIN | MAX | UNIT |
|-----------------|-------------------------------------------------------------|-----------------|-----------------------|-----|------|------|-----|------|
| | | | MIN | TYP | MAX | | | |
| V _{OH} | I _{OH} = -50 μA | 2 V | 1.9 | 2 | | 1.9 | V | |
| | | 3 V | 2.9 | 3 | | 2.9 | | |
| | | 4.5 V | 4.4 | 4.5 | | 4.4 | | |
| | I _{OH} = -4 mA | 3 V | 2.58 | | | 2.48 | | |
| | I _{OH} = -8 mA | 4.5 V | 3.94 | | | 3.8 | | |
| V _{OL} | I _{OL} = 50 μA | 2 V | | | 0.1 | 0.1 | V | |
| | | 3 V | | | 0.1 | 0.1 | | |
| | | 4.5 V | | | 0.1 | 0.1 | | |
| | I _{OL} = 4 mA | 3 V | | | 0.36 | 0.44 | | |
| | I _{OL} = 8 mA | 4.5 V | | | 0.36 | 0.44 | | |
| I _I | V _I = 5.5 V or GND | 0 V to 5.5 V | | | ±0.1 | ±1 | μA | |
| I _{CC} | V _I = V _{CC} or GND, I _O = 0 | 5.5 V | | | 1 | 10 | μA | |
| C _i | V _I = V _{CC} or GND | 5 V | | 2 | 10 | 10 | pF | |

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | LOAD CAPACITANCE | T _A = 25°C | | | MIN | MAX | UNIT |
|------------------|--------------|-------------|------------------------|-----------------------|-----|------|-----|-----|------|
| | | | | MIN | TYP | MAX | | | |
| t _{PLH} | A | Y | C _L = 15 pF | | 5 | 7.1 | 1 | 8.5 | ns |
| t _{PHL} | | | | | 5 | 7.1 | 1 | 8.5 | |
| t _{PLH} | A | Y | C _L = 50 pF | | 7.5 | 10.6 | 1 | 12 | ns |
| t _{PHL} | | | | | 7.5 | 10.6 | 1 | 12 | |

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | LOAD CAPACITANCE | T _A = 25°C | | | MIN | MAX | UNIT |
|------------------|--------------|-------------|------------------------|-----------------------|-----|-----|-----|-----|------|
| | | | | MIN | TYP | MAX | | | |
| t _{PLH} | A | Y | C _L = 15 pF | | 3.8 | 5.5 | 1 | 6.5 | ns |
| t _{PHL} | | | | | 3.8 | 5.5 | 1 | 6.5 | |
| t _{PLH} | A | Y | C _L = 50 pF | | 5.3 | 7.5 | 1 | 8.5 | ns |
| t _{PHL} | | | | | 5.3 | 7.5 | 1 | 8.5 | |

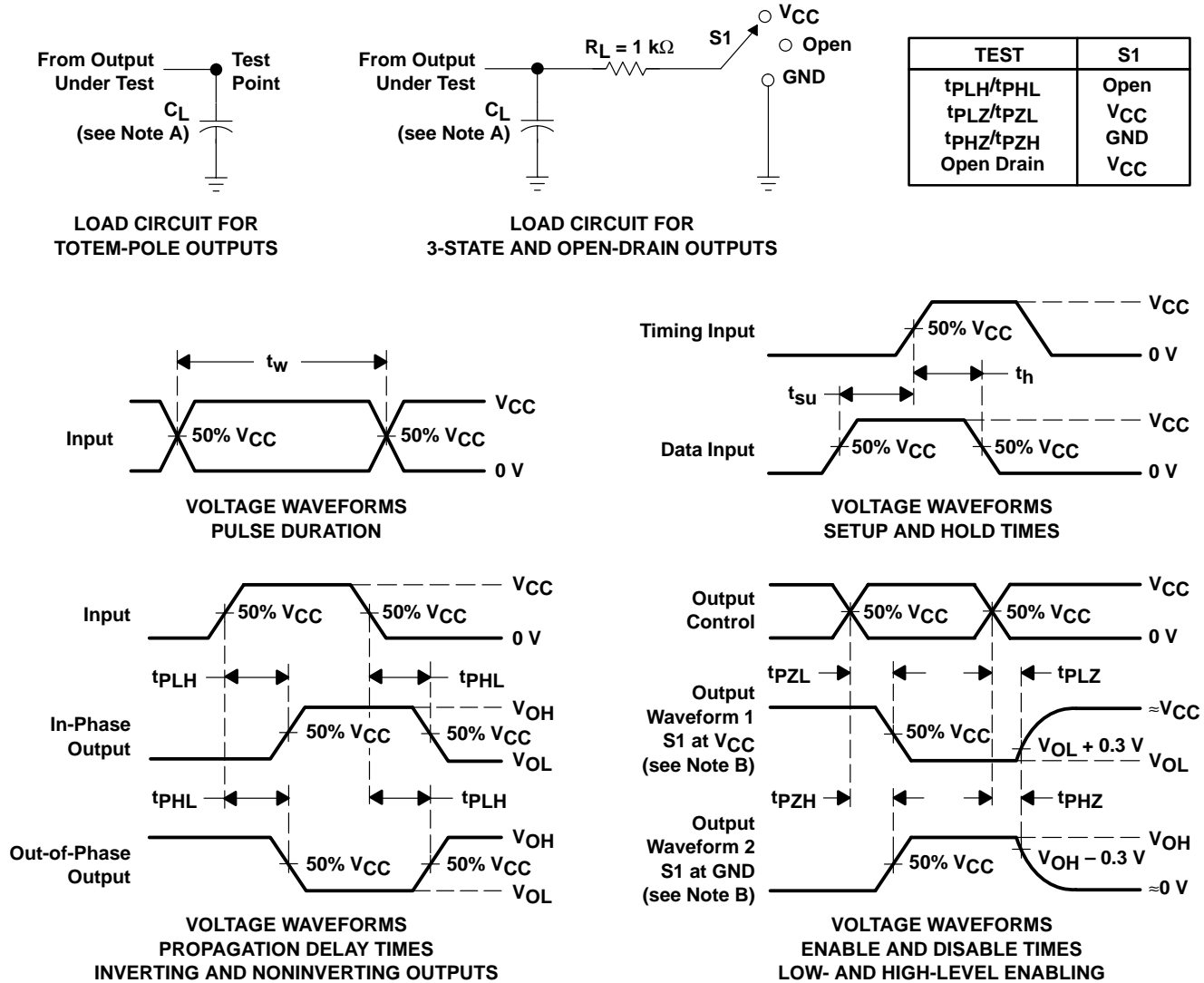
operating characteristics, V_{CC} = 5 V, T_A = 25°C

| PARAMETER | TEST CONDITIONS | TYP | UNIT |
|-----------------------------------------------|--------------------|-----|------|
| C _{pd} Power dissipation capacitance | No load, f = 1 MHz | 12 | pF |

SN74AHC1G04 SINGLE INVERTER GATE

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PARAMETER MEASUREMENT INFORMATION

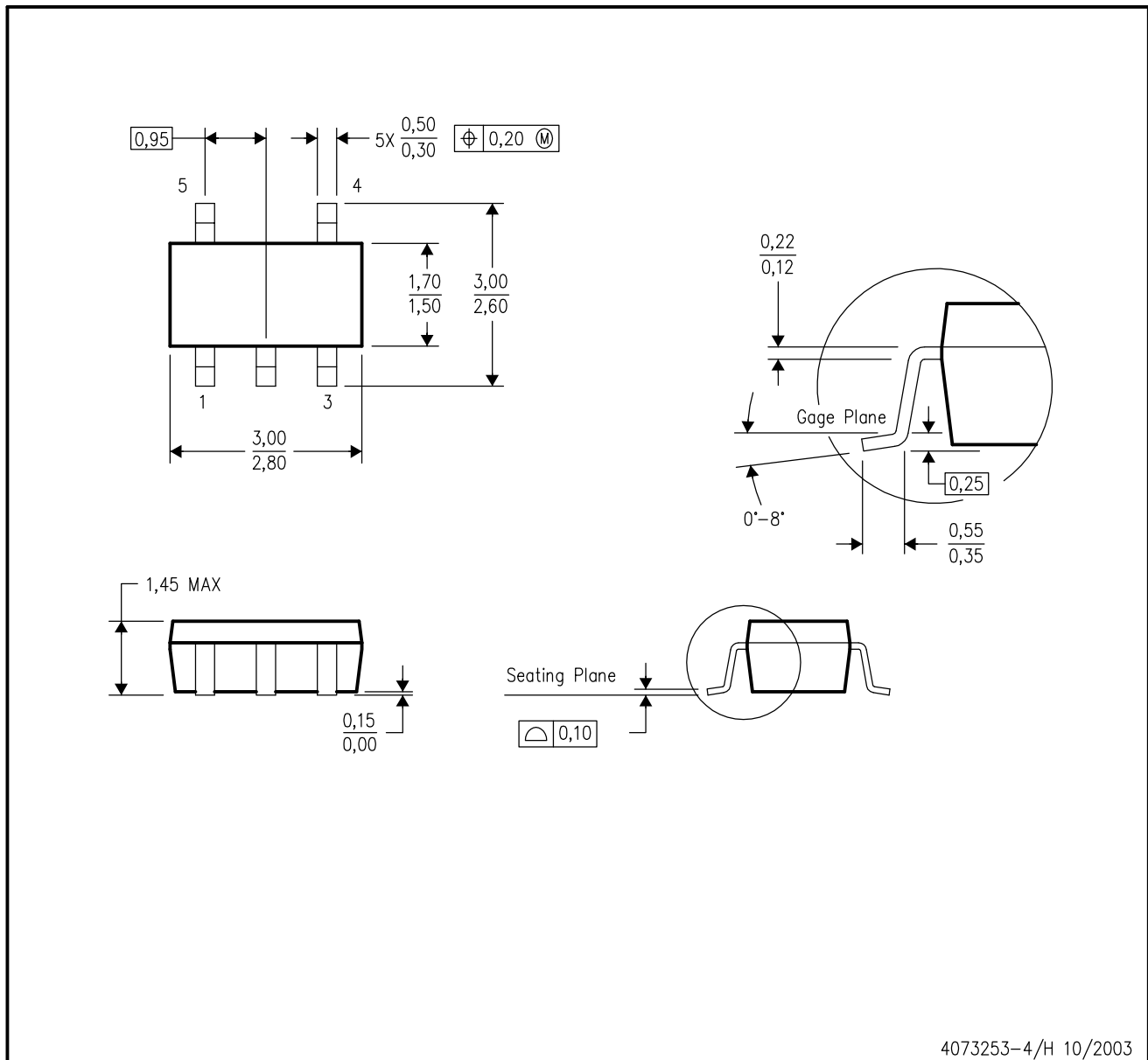


- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 3\text{ ns}$, $t_f \leq 3\text{ ns}$.
 D. The outputs are measured one at a time with one input transition per measurement.
 E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

DBV (R-PDSO-G5)

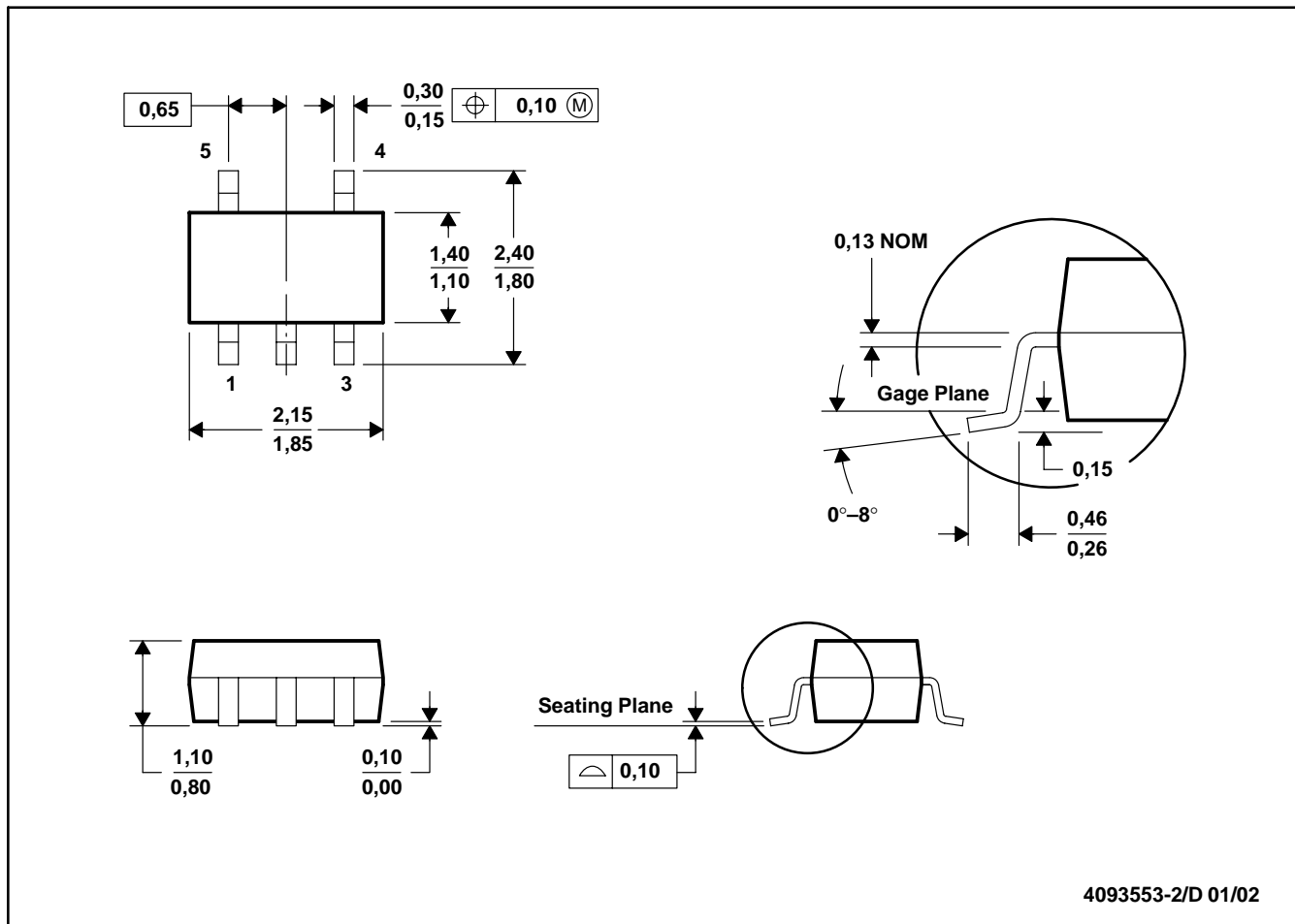
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion.
 - D. Falls within JEDEC MO-178 Variation AA.

DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion.
 D. Falls within JEDEC MO-203

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